

IRLU3410PBF-VB Datasheet

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
100	0.110 at V _{GS} = 10 V	15			
100	0.115 at V _{GS} = 6 V	15			

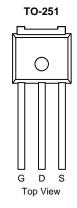
FEATURES

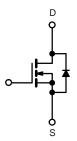
- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- 100 % R_g Tested



APPLICATIONS

· Primary Side Switch





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V _{DS}	100	.,				
Gate-Source Voltage	V _{GS}	± 20	V				
0 1 D 1 O 1 (T 175 00)h	T _C = 25 °C	1	15				
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C	I _D	8.7	7			
Pulsed Drain Current	I _{DM}	45	Α				
Continuous Source Current (Diode Conduction)	I _S	15					
Avalanche Current	I _{AR}	15	7				
Repetitive Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AR}	11.3	mJ			
Mariana Barra Biadadia	T _C = 25 °C	P _D	61 ^b	W			
Maximum Power Dissipation	T _A = 25 °C		2.7 ^a	T vv			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C				

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	16	20			
Junction-to-Ambient*	Steady State		45	55	°C/W		
Junction-to-Case		R _{thJC}	2	2.4			

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static				<u>'</u>			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100		V		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nΑ	
		V _{DS} = 100 V, V _{GS} = 0 V		1			
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	15			Α	
		V _{GS} = 10 V, I _D = 15 A		0.110		Ω	
5	D	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C		0.170			
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C		0.230			
		$V_{GS} = 6 \text{ V}, I_{D} = 10 \text{ A}$		0.115			
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 15 A		25		S	
Dynamic ^a							
Input Capacitance	C _{iss}			892		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C _{rss}			70			
Total Gate Charge ^c	Q_g			20	25		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$		5.5		nC	
Gate-Drain Charge ^c	Q_{gd}			7			
Gate Resistance	R_g		1		3.2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	12		
Rise Time ^c	t _r	$V_{DD} = 75 \text{ V}, R_L = 5 \Omega$		35	55		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 15 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		17	25	ns	
Fall Time ^c	t _f			30	45		
Source-Drain Diode Ratings and Cha	racteristic (T	_C = 25 °C)					
Pulsed Current	I _{SM}				45	Α	
Diode Forward Voltage ^b	V_{SD}	I _F = 15 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 15 A, dl/dt = 100 A/μs		55	85	ns	

Notes:

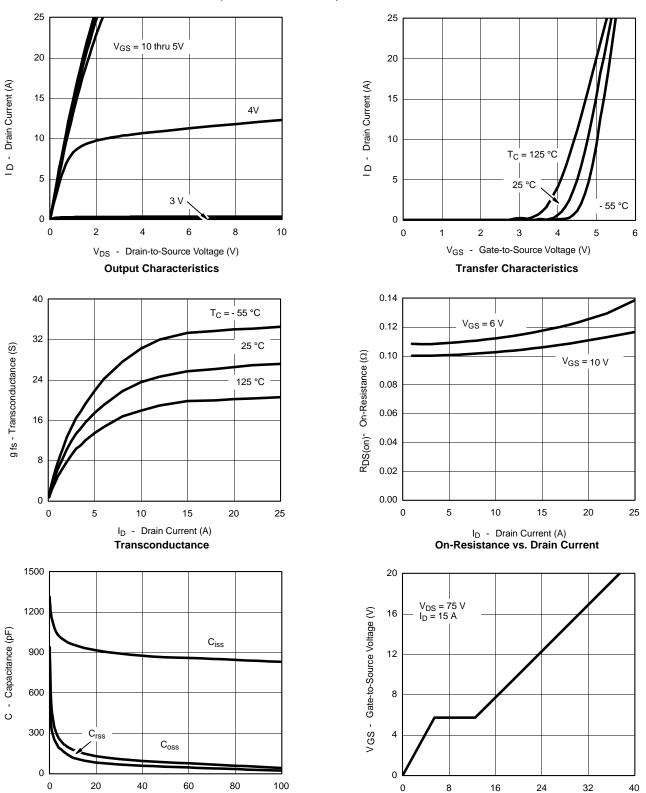
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C unless noted)



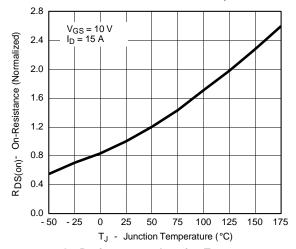
V_{DS} - Drain-to-Source Voltage (V) **Capacitance**

 $Q_g\,$ - Total Gate Charge (nC)

Gate Charge

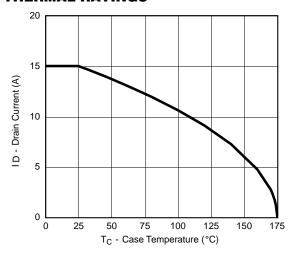


TYPICAL CHARACTERISTICS (25 °C unless noted)

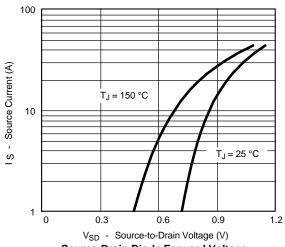


On-Resistance vs. Junction Temperature

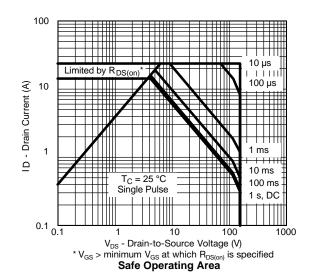
THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature



Source-Drain Diode Forward Voltage

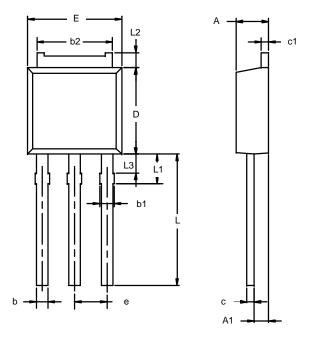


2 Duty Cycle = 0.5 Normalized Effective Transient Thermal Impedance 0.2 0.1 0.05 зΠ Single Pulse 0.01 10-4 10-3 10 Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
E	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
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